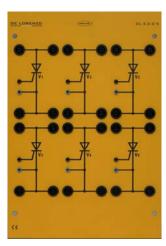




GROUP OF SCR



DL 2605

Six silicon controlled rectifiers with RCD protection network used for realizing controlled rectifiers and inverters.

Technical features:

Direct average current:

 I_{TAV} = 7.6 A max. True RMS value of the direct current: I_{TRMS} = 12 A Max. repetitive reverse voltage: U_{RRM} = 800 V Trigger current: I_{GT} = 15 mA max. Trigger voltage: U_{GT} = 1.5 V max. I_{T}^2 = 72 I_{T}^2 A I_{T}^2

TRIAC



DL 2607

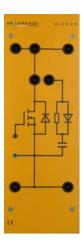
Bidirectional thyristor used for the control in alternated current.
Complete with RC

suppressor network.

Technical features:

True RMS value of the direct current: $I_{TAV} = 8 A max.$ Non-repetitive peak current: $I_{TSM} = 70 \text{ A}, 50 \text{Hz} (77 \text{A},$ 60Hz) Max. repetitive reverse voltage: $U_{DRM} = 800 \text{ V}$ Trigger current: $I_{GT} = 25 \text{ mA max.}$ (all the quadrants) Trigger voltage: $U_{GT} = 2.5 \text{ V max}.$ State keeping current: $I_H = 25 \text{ mA max}.$

MOSFET



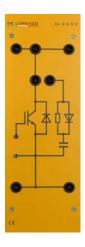
DL 2608

N-channel enhancement mode power MOS with integrated reverse diode (FRED, Fast Recovery Epitaxial Diode) used as very fast switch in switching regulators and inverters.

Technical features:

Drain-source voltage: $U_{DS} = 400 \text{ V}$ Continuous drain current: $I_D = 10 \text{ A}$ Drain-source on-state resistance: $R_{DS}(on) = 0.55 \Omega$ Gate-source voltage: $U_{GS} = +-20 \text{ V}$

IGBT



DL 2609

N-channel Insulated Gate Bipolar Transistor (IGBT) with anti parallel hyper fast protection diode used as very fast switch in switching regulators and inverters.

 $I^2t = 24 A^2s$

Technical features:

Collector-emitter voltage: $U_{CES} = 600 \text{ V}$ Continuous collector current: $I_c=24 \text{ A}$ at $T_c=25^{\circ}\text{C}$ Collector-emitter saturation voltage: $U_{CESat} = 1.8 \text{ V}_{typ}$ at $I_c=15 \text{ A}$ Gate-emitter voltage: $U_{GE} = \pm 20 \text{ V}$